

30V P-Channel Enhancement Mode MOSFET

Description

The NP3401 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

General Features

- ◆ $V_{DS} = -30V$, $I_D = -4.2A$
 $R_{DS(ON)}(\text{Typ.}) = 53m\Omega$ @ $V_{GS} = -4.5V$
 $R_{DS(ON)}(\text{Typ.}) = 73m\Omega$ @ $V_{GS} = -2.5V$
- ◆ High power and current handling capability
- ◆ Lead free product is acquired
- ◆ Surface mount package

Application

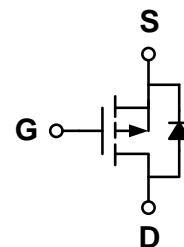
- ◆ PWM applications
- ◆ Load switch

Package

- ◆ SOT-23

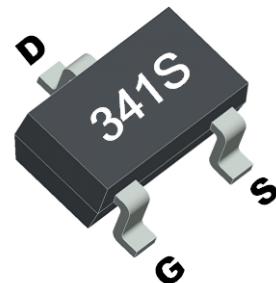


Schematic diagram



Marking and pin assignment

SOT-23
(TOP VIEW)



Ordering Information

| Part Number | Storage Temperature | Package | Devices Per Reel |
|-------------|---------------------|---------|------------------|
| NP3401VR-G | -55°C to +150°C | SOT-23 | 3000 |

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

| parameter | symbol | limit | unit |
|--|----------------------------|---------------------|------|
| Drain-source voltage | V_{DS} | -30 | V |
| Gate-source voltage | V_{GS} | ± 12 | V |
| Continuous Drain Current ($T_J = 150^{\circ}\text{C}$) | $T_C = 25^{\circ}\text{C}$ | -4.2 | A |
| | $T_C = 70^{\circ}\text{C}$ | -3.5 | |
| | $T_A = 25^{\circ}\text{C}$ | -3.7 ^{b,c} | |
| | $T_A = 70^{\circ}\text{C}$ | -2.9 ^{b,c} | |
| Continuous Source-Drain Diode Current | $T_C = 25^{\circ}\text{C}$ | -1.4 | |
| | $T_A = 25^{\circ}\text{C}$ | -1 ^{b,c} | |
| Pulsed Drain Current ($t = 300 \mu\text{s}$) | I_{DM} | -12.8 | |

| | | | | |
|--|----------------------|--------------------------------|--------------------|----|
| Maximum power dissipation | T _C =25°C | P _D | 1.7 | W |
| | T _C =70°C | | 1.1 | |
| | T _A =25°C | | 1 ^{b,c} | |
| | T _A =70°C | | 0.6 ^{b,c} | |
| Operating Junction and Storage Temperature Range | | T _{J,T_{STG}} | -55—150 | °C |

Thermal Characteristics

| Parameter | Symbol | Typical | Maximum | Unit |
|--|--------------|------------------|---------|------|
| Maximum Junction-to-Ambient ^{b,d} | t ≤ 5 s | R _{θJA} | 100 | °C/W |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{θJF} | 60 | |

Notes:

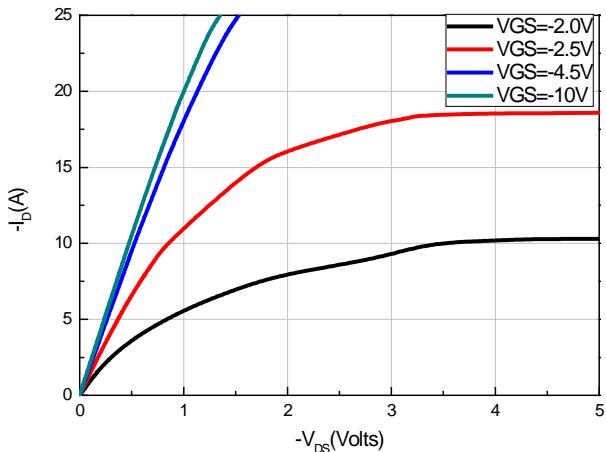
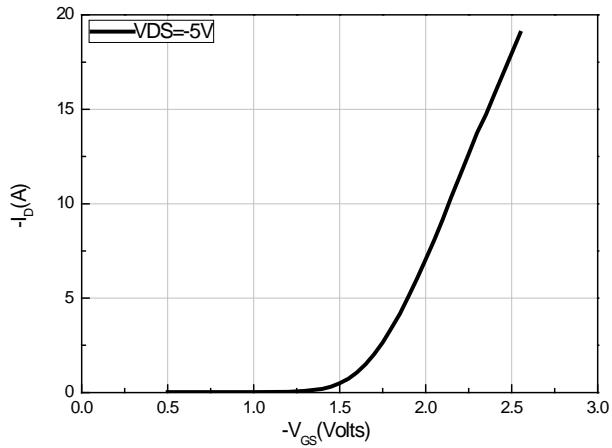
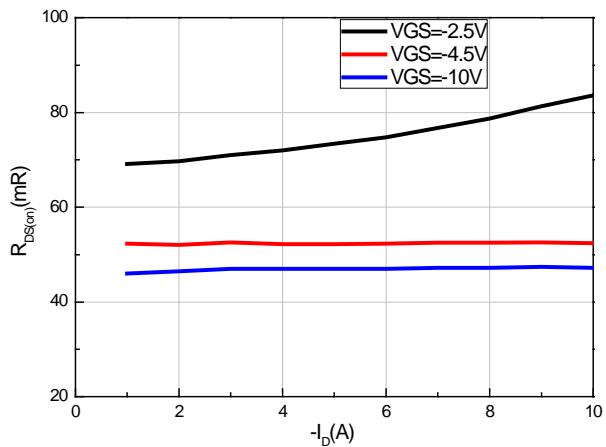
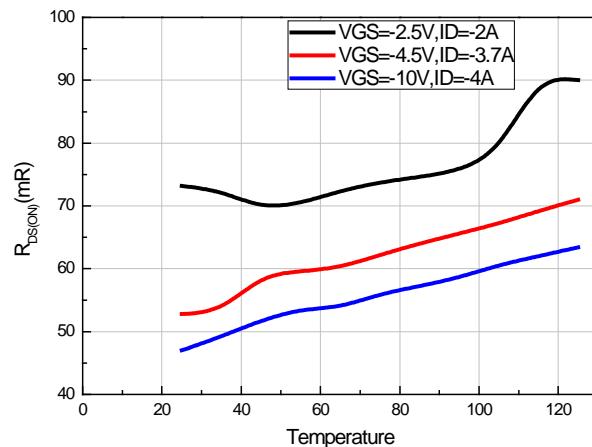
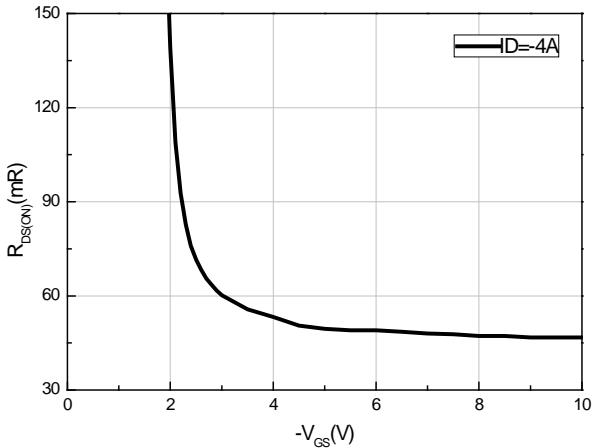
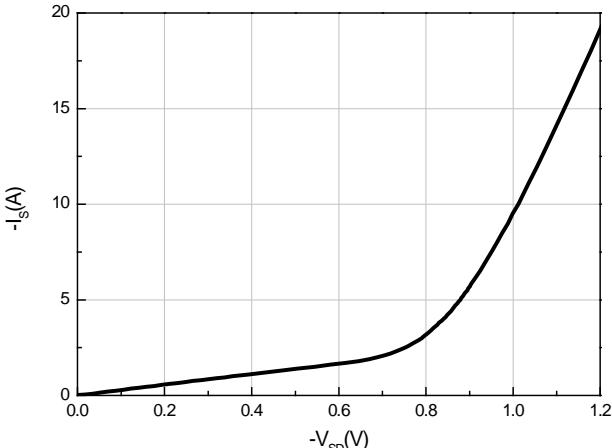
- a. TC = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 175 °C/W.

Electrical Characteristics (TA=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|----------------------------------|---------------------|--|------|-------|------|------|
| OFF Characteristics | | | | | | |
| Drain-source breakdown voltage | BV _{DSS} | V _{GS} =0V, I _D =-250μA | -30 | - | - | V |
| Zero gate voltage drain current | I _{DSS} | V _{DS} =-30V, V _{GS} =0V | - | - | -1 | μA |
| Gate-body leakage | I _{GSS} | V _{DS} =0V, V _{GS} =±12V | - | - | ±100 | nA |
| ON Characteristics | | | | | | |
| Gate threshold voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =-250μA | -0.5 | -0.83 | -1.3 | V |
| Drain-source on-state resistance | R _{DS(ON)} | V _{GS} =-4.5V, I _D =-4A | - | 53 | 65 | mΩ |
| | | V _{GS} =-2.5V, I _D =-1A | - | 73 | 85 | |
| Forward transconductance | g _f | V _{DS} =-5V, I _D =-4A | - | 11 | - | S |
| Dynamic Characteristics | | | | | | |
| Input capacitance | C _{ISS} | V _{DS} =-15V , V _{GS} =0V f=1.0MHz | - | 880 | - | pF |
| Output capacitance | C _{OSS} | | - | 105 | - | |
| Reverse transfer capacitance | C _{RSS} | | - | 65 | - | |
| Switching Characteristics | | | | | | |
| Turn-on delay time | t _{D(ON)} | V _{DD} =-15V I _D =-4A V _{GEN} =-10V R _L =3.6ohm R _{GEN} =6ohm | - | 7 | - | ns |
| Rise time | t _r | | - | 3 | - | |
| Turn-off delay time | t _{D(OFF)} | | - | 30 | - | |
| Fall time | t _f | | - | 12 | - | |
| Total gate charge | Q _g | V _{DS} =-15V,I _D =-4A V _{GS} =-4.5V | - | 8.5 | - | nC |
| Gate-source charge | Q _{gs} | | - | 1.8 | - | |
| Gate-drain charge | Q _{gd} | | - | 2.7 | - | |

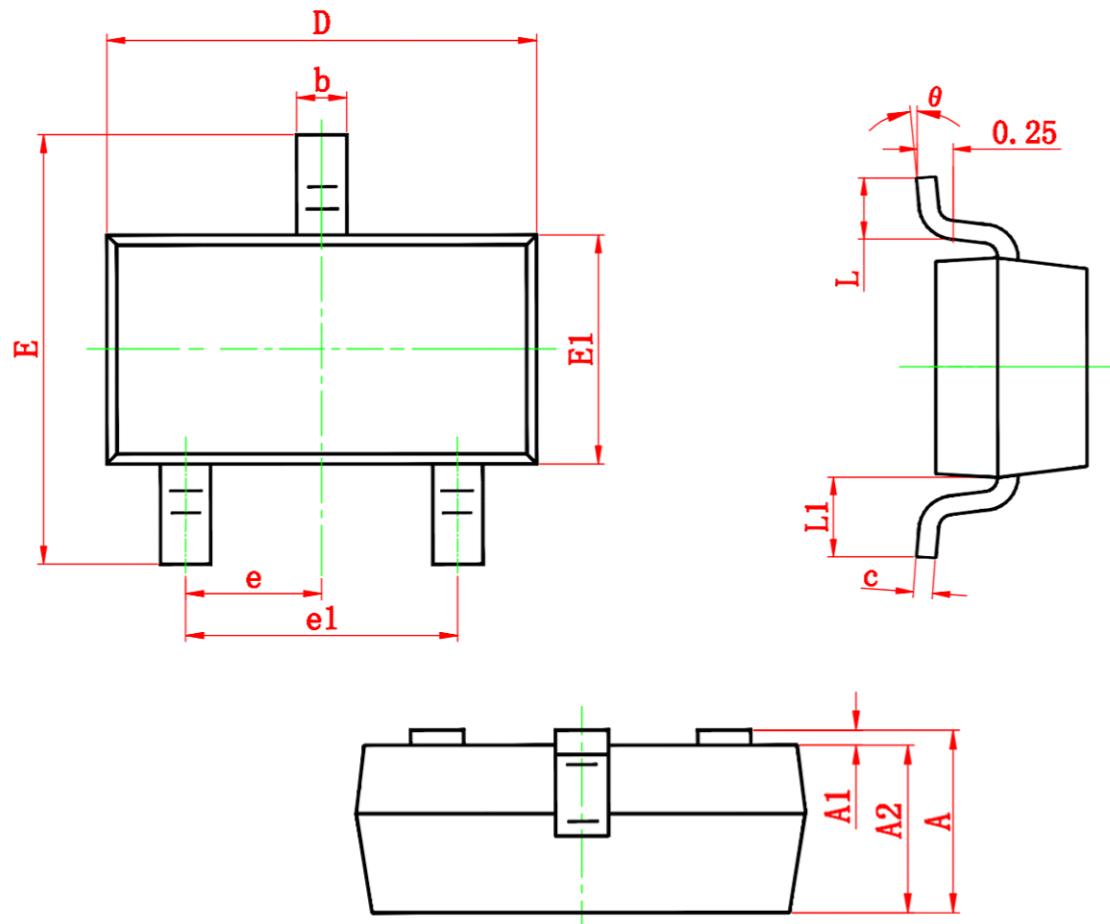
DRAIN-SOURCE DIODE CHARACTERISTICS

| | | | | | | |
|-----------------------|----------|----------------------|---|-------|------|---|
| Diode forward voltage | V_{SD} | $V_{GS}=0V, I_s=-4A$ | - | -0.81 | -1.2 | V |
|-----------------------|----------|----------------------|---|-------|------|---|

Typical Performance Characteristics

Fig 1: On-Region Characteristics

Figure 2: Transfer Characteristics

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

Figure 5: On-Resistance vs. Gate-Source Voltage

Figure 6: Body-Diode Characteristics

Package Information

- SOT-23



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 0.900 | 1.150 | 0.035 | 0.045 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 0.900 | 1.050 | 0.035 | 0.041 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.080 | 0.150 | 0.003 | 0.006 |
| D | 2.800 | 3.000 | 0.110 | 0.118 |
| E | 2.250 | 2.550 | 0.089 | 0.100 |
| E1 | 1.200 | 1.400 | 0.047 | 0.055 |
| e | 0.950 TYP. | | 0.037 TYP. | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.300 | 0.500 | 0.012 | 0.020 |
| L1 | 0.550 REF. | | 0.022 REF. | |
| θ | 0° | 8° | 0° | 8° |